Product Change Notification - KSRA-23MARA638

Date:	04 Dec 2017						
Product Category:	Binary and BCD A/D Converters; Dual Slope A/D Converters						
Notification subject:	CCB 3043 Final Notice: Qualification of GTK as a new assembly site for selected products available in						
	24L SOIC package.						
Notification text:	PCN Status: Final notification						
	PCN Type: Manufacturing Change						
	Microchip Parts Affected: Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.						
	NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).						
	Description of Change:						

Qualification of GTK as a new assembly site for selected products available in 24L SOIC package.

Pre Change:

Assembled at ANAP assembly site using 8290 die attach material

Post Change:

Assembled at GTK assembly site using EN-4900GC die attach material

Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	Amkor Technology Philippine (P1/P2), INC. (ANAP)	Greatek Eletronic Inc. (GTK)
Wire material	Gold (Au) Wire	Gold (Au) Wire
Die attach material	8290	EN-4900GC
Molding compound material	G600	G600
Lead frame material	C194	C194

Impacts to Data Sheet: None

Change Impact: None

Reason for Change:

To improve on time delivery performance by qualifying GTK as new assembly site

Change Implementation Status:

In Progress

Etimated First Ship Date:

January 04, 2018 (date code: 1801)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	August 2017			> December 2017				,	January 2018							
Workweek	31	32	33	34	35		48	49	50	51	52	01	02	03	04	05
Initial PCN Issue Date	x															
Qual Report Availability								Х								
Final PCN Issue Date								Х								
Estimated Implementation Date												х				

Method to Identify Change: Traceability code

Qualification Report: Please open the attachments included with this PCN labeled as PCN_#_Qual Report

Revision History: August 02, 2017: Issued initial notification.

December 04, 2017: Issued final notification. Attached the Qualification Report. Revised the affected parts list. Provided estimated first ship date on January 04, 2018.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_KSRA-23MARA638_Affected CPN.pdf PCN_KSRA-23MARA638_Qual Report.pdf PCN_KSRA-23MARA638_Affected CPN.xlsx

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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KSRA-23MARA638-CCB 3043 Final Notice: Qualification of GTK as a new assembly site for selected products available in 24L SOIC package.

Affected Catalog Part Numbers (CPN)

PCN_KSRA-23MARA638
CATALOG_PART_NBR
TC14433ACOG
TC14433AEOG
TC14433COG
TC14433EOG
TC510COG
TC510COG713
TC510EOG
TC510EOG713